



Product Change Notification

Change Notification #: 115821 - 00
Change Title: Select Intel® SSD DC P3520 Series Products,
PCN 115821-00, Label,
PDR BSMI RoHS logo label update
Date of Publication: October 2, 2017

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 31, 2017
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Description of Change to the Customer:

The Intel® SSD DC P3520 Series SKUs listed in the Products Affected Table below will have the following change.

Change 1 for AIC PDR Label:

- Dash up Customer label IPN: H83691-001 to H83691-002
- Dash up Customer label spec: H8369101 to H8369102
- Dash up Customer blank label: H20609-004 to H20609-005

Change #2 for SFF PDR Label:

- Dash up Customer label IPN: H65826-001 to H65826-002
- Dash up Customer label spec: H6582601 to H6582602
- Dash up Customer blank label: H33014-002 to H33014-003

Please refer to the images below for label changes.

AIC Label Changes:

- H20609-004 (2-in-1 label)
- 140mm*10mm Blank label
- 55mm*7.5mm Regulatory label

Current PDR AIC Generic Label



55mm*7.5mm



- H20609-005 (2-in-1 label)
- 140mm*10mm Blank label
- 45mm*7.5mm Regulatory label

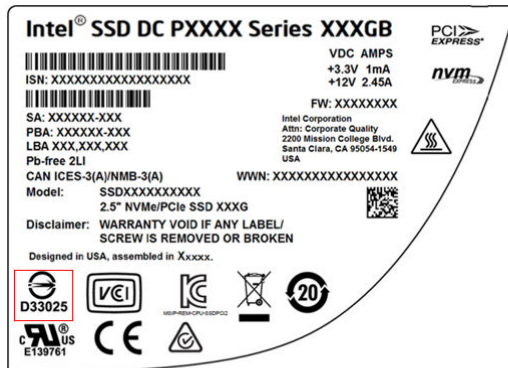
New PDR AIC Generic Label



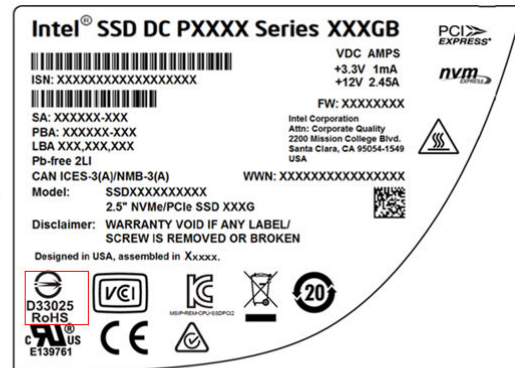
45mm*7.5mm

SFF Label Changes:

Current PDR 2.5 Generic Label H33014-002



New PDR2.5 Generic Label H33014-003



Use new Taiwan BSMI (RoHS) logo

Customer Impact of Change and Recommended Action:

There is no change to the Form, Fit, or Function of the product. The change is only to the labels used in packaging.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

* Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P3520 Series (1.2TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic 10 Pack	SSDPE2MX012T710	943981
Intel Solid State Drive 1.0 TB PCIe 2.5" Drive Generic 10 Pack	SSDPE2MX010T710	954353
Intel Solid State Drive 1.0 TB PCIe 2.5" Drive Generic Single Pack	SSDPE2MX010T701	954352
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX020T701	943972
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPEDMX020T701	943974
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPE2MX012T701	943973
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic Single Pack	SSDPEDMX012T701	943979
Intel® SSD DC P3520 Series (2.0TB, 2.5in PCIe 3.0 x4, 3D1, MLC) Generic 10 Pack	SSDPE2MX020T710	943982

PCN Revision History:

Date of Revision:

October 2, 2017

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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